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February 2009

FSUSB31

Low-Power, Single-Port, High-Speed USB 2.0 (480Mbps) Switch

Features

- Low On Capacitance: 3.7pF (Typical)
 Low On Resistance: 6.5Ω (Typical)
- Low Power Consumption: 1µA (Maximum)
 - 10μA Maximum I_{CCT} Over an Expanded Control Voltage Range: V_{IN} = 2.6V, V_{CC} = 4.3V
- Wide -3dB Bandwidth: > 720MHz■ 8kV I/O to GND ESD Protection
- Power-off Protection When V_{CC} = 0V, D+/D- Pins Can Tolerate up to 5.5V
- Packaged in:
 - 8-lead MicroPak™ (1.6 x 1.6mm)
 - 8-lead US8
 - 8-lead Ultrathin MLP (1.2 x 1.4mm)

Applications

- Cell Phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-top Box

Related Resources

■ AN-6022 Using the FSUSB30/31 to Comply with USB 2.0 Fault Condition Requirements

Description

The FSUSB31 is a low-power, single-port, high-speed USB 2.0 switch. This part is configured as a double-pole, single-throw switch and is optimized for switching or isolating a high-speed (480Mbps) source or a high-speed and full-speed (12Mbps) source. The FSUSB31 is compatible with the requirements of USB2.0 and features an extremely low on capacitance (C_{ON}) of 3.7pF. The wide bandwidth of this device (>720MHz) exceeds the bandwidth needed to pass the third harmonic, resulting in signals with minimum edge and phase distortion. Superior channel-to-channel crosstalk minimizes interference.

The FSUSB31 contains special circuitry on the D+/D-pins that allows the device to withstand an over-voltage condition. This device is also designed to minimize current consumption even when the control voltage applied to the $\overline{\text{OE}}$ pin is lower than the supply voltage (V_{CC}). This feature is especially valuable for mobile applications, such as cell phones, allowing direct interface with the general-purpose I/Os of the baseband processor. Other applications include port isolation and switching in portable cell phones, PDAs, digital cameras, printers, and notebook computers.

Ordering Information

Part Number	Package	Eco Status	Package Description
FSUSB31K8X	MAB08A	Green	8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide
FSUSB31L8X	MAC08A	RoHS	8-Lead MicroPak, 1.6mm Wide
FSUSB31UMX	UMLP08A	Green	8-Lead, Ultrathin Molded Leadless Package (UMLP), 1.2 x 1.4mm

(a) For Fairchild's definition of "green" Eco Status, please visit: http://www.fairchildsemi.com/company/green/rohs_green.html.

Application Diagram

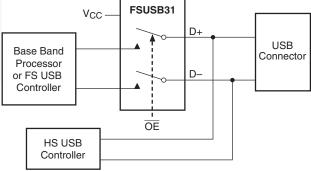


Figure 1. Typical Application Diagram

MicroPak™ is a trademark of Fairchild Semiconductor Corporation.

Analog Symbol

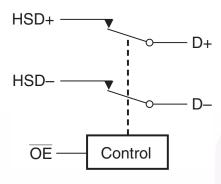


Figure 2. Analog Symbol

Connection Diagrams

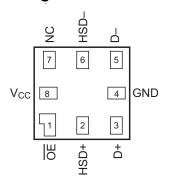


Figure 3. Pin Assignments for MicroPak

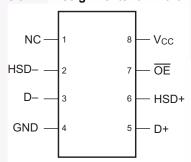


Figure 4. Pin Assignments for US8

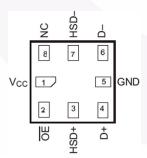


Figure 5. Pin Assignments for UMLP

Pin Descriptions

Pin Name	Description
ŌE	Bus Switch Enable
D+, D-, HSD+, HSD-	Data Ports
NC	No Connect

Truth Table

ŌE	Function
HIGH	Disconnect
LOW	D+, D- = HSD+, HSD-

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Para	Minimum	Maximum	Unit	
V _{CC}	Supply Voltage		-0.5	5.5	V
V _S	DC Input Voltage ⁽¹⁾		-0.5	V _{CC}	V
\/	DC Switch Voltage ⁽¹⁾	HSD	-0.5	V_{CC}	V
V _{IN}	DC Switch voltage	D+, D-	-0.5	V_{CC}	V
I _{IK}	DC Input Diode Current	-50		mA	
I _{OUT}	DC Output Current			50	mA
T _{STG}	Storage Temperature		-65	+150	°C
ESD	Human Body Model: JESD22-A114	All Pins		7.5	kV
LOD		I/O to GND		8	kV

Note:

1. The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Minimum	Maximum	Unit
V _{CC}	Supply Voltage	3.0	4.3	V
V _{IN}	Control Input Voltage ⁽²⁾	0	V _{CC}	V
	Switch Input Voltage	0	V_{CC}	V
T _A	Operating Temperature	-40	+85	°C

Note:

2. Control input must be held HIGH or LOW and it must not float.

DC Electrical Characteristics

All typical values are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V _{CC} (V)	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			Unit
Symbol	Parameter	Conditions	ACC (A)	Min.	Тур.	Max.	51110
V _{IK}	Clamp Diode Voltage	I _{IN} = -18mA	3.0			-1.2	V
V	Input Voltage HIGH		3.0 to 3.6	1.3			V
V _{IH}	Iliput voltage niGn		4.3	1.7			
V	Input Voltage LOW		3.0 to 3.6			0.5	V
V _{IL}	Input Voltage LOW		4.3			0.7	
I _{IN}	Control Input Leakage	V _{IN} = 0V to V _{CC}	0 to V _{CC}	-1.0		1.0	μΑ
I _{OZ}	OFF State Leakage	$0 \le HSD \le V_{CC}$	4.3	-2.0		2.0	μΑ
I _{OFF}	Power OFF Leakage Current (D+, D–)	$V_{IN} = 0.0V \text{ to } 4.3V, V_{CC} = 0V$	0	-2.0		2.0	μΑ
R _{ON}	Switch On Resistance ⁽³⁾	$V_{IN} = 0.4V$, $I_{ON} = -8mA$	3.0		6.5	10.0	Ω
ΔR_{ON}	Delta R _{ON} ⁽⁴⁾	$V_{IN} = 0.4V$, $I_{ON} = -8mA$	3.0		0.35		Ω
R _{ON} Flatness	R _{ON} Flatness ⁽³⁾	$V_{IN} = 0.0V - 1.0V,$ $I_{ON} = -8mA$	3.0		2.0		Ω
I _{CC}	Quiescent Supply Current	$V_{IN} = 0.0V \text{ or } V_{CC},$ $I_{OUT} = 0$	4.3			1.0	μΑ
Ісст	Increase in I _{CC} Current per Control Voltage and V _{CC} Levels	V _{IN} = 2.6V, V _{CC} = 4.3V	4.3			10.0	μΑ

Notes:

- 3. Measured by the voltage drop between Dn, HSD, and Dn pins at the indicated current through the switch. On resistance is determined by the lower of the voltage on the two ports.
- 4. Guaranteed by characterization.

AC Electrical Characteristics

All typical values are for V_{CC} = 3.3V are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V _{CC} (V)	T _A = -	40°C to	+85°C	Unit	Figure	
Symbol	raiametei	Conditions	VCC (V)	Min.	Тур.	Max.	Oilit	Number	
t _{ON}	Turn-On Time, OE to Output	V_{IN} = 0.8V, R_L = 50 Ω , C_L = 5pF	3.0 to 3.6		15.0	30.0	ns	Figure 13	
t _{OFF}	Turn-Off Time, OE to Output	V_{IN} = 0.8V, R_L = 50 Ω , C_L = 5pF	3.0 to 3.6		12.0	25.0	ns	Figure 13	
t _{PD}	Propagation Delay ⁽⁵⁾	$R_L = 50\Omega$, $C_L = 5pF$	3.3		0.25		ns	Figure 11 Figure 12	
t _{BBM}	Break-Before-Make	$R_L = 50\Omega, C_L = 5pF,$ $V_{IN} = 0.8V$	3.0 to 3.6	2.0		6.5	ns	Figure 14	
O _{IRR}	Off Isolation (Non-Adjacent)	$R_T = 50\Omega$, $f = 240MHz$	3.0 to 3.6		-35.0		dB	Figure 17	
Xtalk	Non-Adjacent Channel Crosstalk	$R_T = 50\Omega$, $f = 240MHz$	3.0 to 3.6		-55.0		dB	Figure 18	
BW	BW -3dB Bandwidth $R_T = 50\Omega$, $C_L = 0pF$ 3.0 to 3.6		2.0 to 2.6				oF 3.0 to 3.6	MHz	Figure 16
DVV	-Sub Danawidin	$R_T = 50\Omega$, $C_L = 5pF$	5.0 10 5.0		550		IVII IZ	i igule 10	

Note:

5. Guaranteed by characterization.

USB Hi-Speed Related AC Electrical Characteristics

Symbol Parameter		Conditions	V _{CC} (V)	T _A = -40°C to +85°C			Unit	Figure Number
				Min.	Тур.	Max.		Number
t _{SK(O)}	Channel-to-Chan- nel Skew ⁽⁶⁾	C _L = 5pF	3.0 to 3.6		50.0		ps	Figure 11 Figure 15
t _{SK(P)}	Skew of Opposite Transitions of the Same Output ⁽⁶⁾	C _L = 5pF	3.0 to 3.6		20.0		ps	Figure 11 Figure 15
tJ	Total Jitter ⁽⁶⁾	$R_L = 50\Omega$, $C_L = 5pF$, $t_R = t_F = 500ps$ at 480 Mbps $(PRBS = 2^{15} - 1)$	3.0 to 3.6		200		ps	

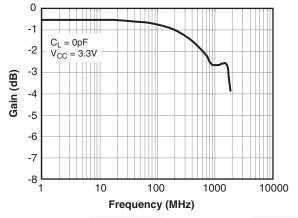
Note:

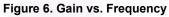
6. Guaranteed by design.

Capacitance

Symbol	Parameter	Conditions	T _A = -	40°C to	Unit	Figure	
Symbol	i didilietei	Conditions	Min.	Тур.	Max.	Oiiit	Number
C _{IN}	Control Pin Input Capacitance	V _{CC} = 0V		1.0		pF	Figure 20
C _{ON}	On Capacitance	$V_{CC} = 3.3V, \overline{OE} = 0V$		3.7		pF	Figure 19
C _{OFF}	Off Capacitance	V_{CC} and \overline{OE} = 3.3V		1.7		pF	Figure 20

Typical Characteristics





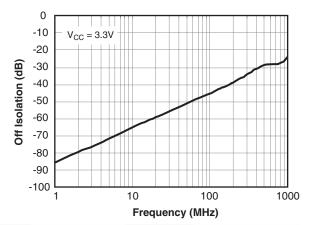


Figure 7. Off Isolation

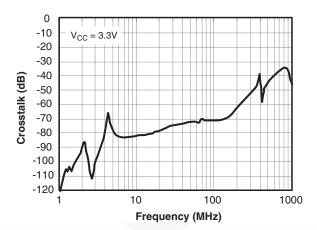


Figure 8. Crosstalk

Test Diagrams

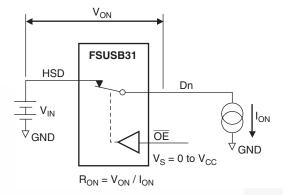
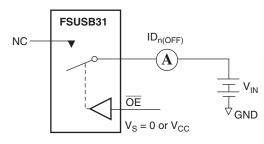
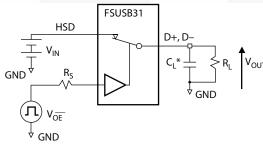


Figure 9. On Resistance



Each switch port is tested separately.

Figure 10. Off Leakage



 $R_{L},\,R_{S},\,\text{and}\,\,C_{L}$ are functions of the application environment (see AC Electrical tables for specific values).

*C_L includes test fixture and stray capacitance.

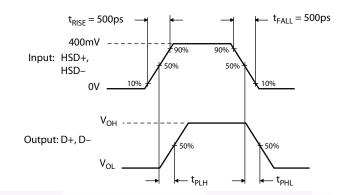


Figure 11. AC Test Circuit Load

Figure 12. Switch Propagation Delay Waveforms (t_{PD})

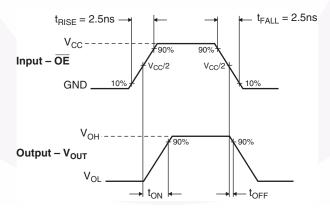
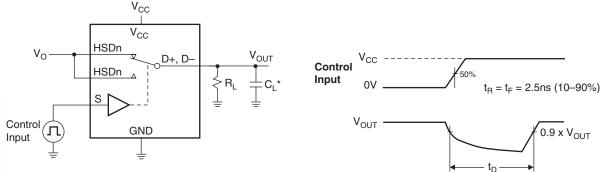


Figure 13. Turn On / Turn Off Waveform (t_{ON} / t_{OFF})

Test Diagrams (Continued)



^{*}C_L includes test fixture and stray capacitance.

Figure 14. Break-Before-Make (t_{BBM})

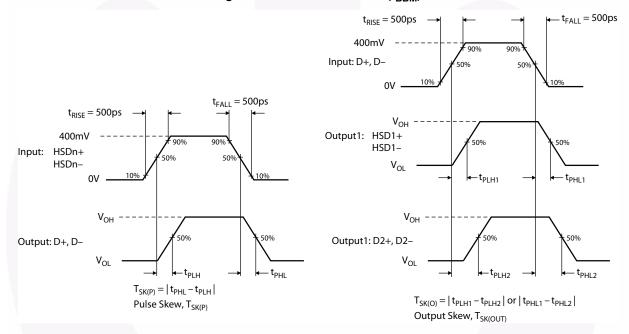


Figure 15. Switch Skew Tests

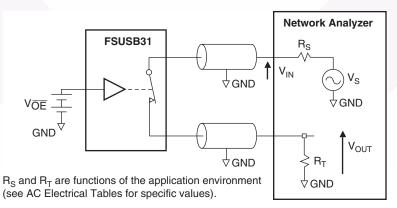


Figure 16. Bandwidth

Test Diagrams (Continued)

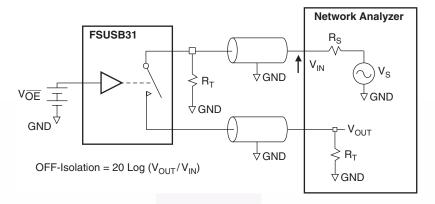


Figure 17. Channel Off Isolation

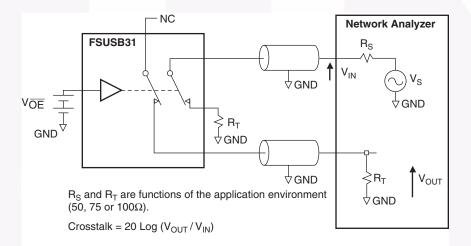


Figure 18. Non-Adjacent Channel-to-Channel Crosstalk

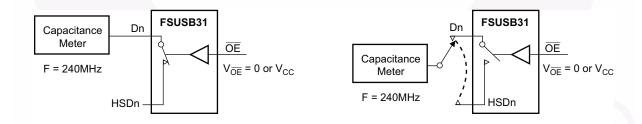


Figure 19. Channel On Capacitance

Figure 20. Channel Off Capacitance

Application Guidance: Meeting USB 2.0 Vbus Short Requirements

In section 7.1.1 of the USB 2.0 specification, it notes that USB devices must be able to withstand a Vbus short to D+ or D- when the USB devices is either powered off or powered on. The FSUSB31 can be successfully configured to meet both these requirements.

Power-Off Protection

For a Vbus short circuit, the switch is expected to withstand such a condition for at least 24 hours. The FSUSB31 has specially designed circuitry which prevents unintended signal bleed through as well as guaranteed system reliability during a power-down, overvoltage condition. The protection has been added to the common pins (D+, D-).

Power-On Protection

The USB 2.0 specification also notes that the USB device should be capable of withstanding a Vbus short during transmission of data. Fairchild recommends adding a 100Ω series resister between the switch VCC pin and supply rail to protect against this case. This modification works by limiting current flow back into the VCC rail during the over-voltage event so current remains within the safe operating range. In this application, the switch passes the full 5.25V input signal through to the selected output, while maintaining specified off isolation on the un-selected pins.

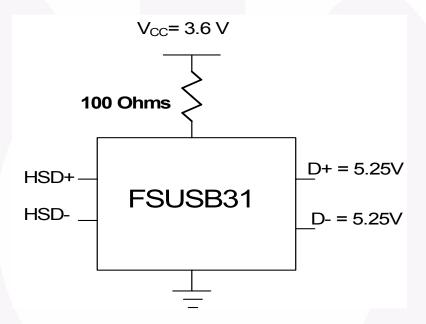
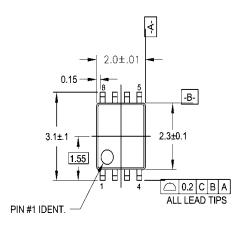
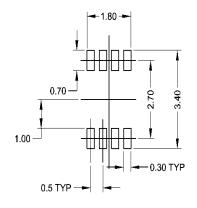


Figure 21. A 100 Ω resistor in series with the V_{CC} supply allows the FSUSB31 to withstand a Vbus short when powered up

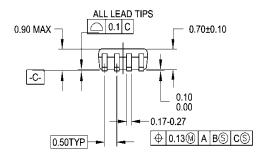
For more information, see Applications Note AN-6022 — Using the FSUSB30/FSUSB31 to Comply with USB 2.0 Fault Condition Requirements at www.fairchildsemi.com.

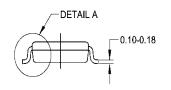
Physical Dimensions

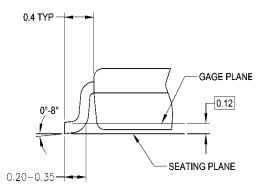




LAND PATTERN RECOMMENDATION







NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-187
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

DETAIL A

MAB08AREVC

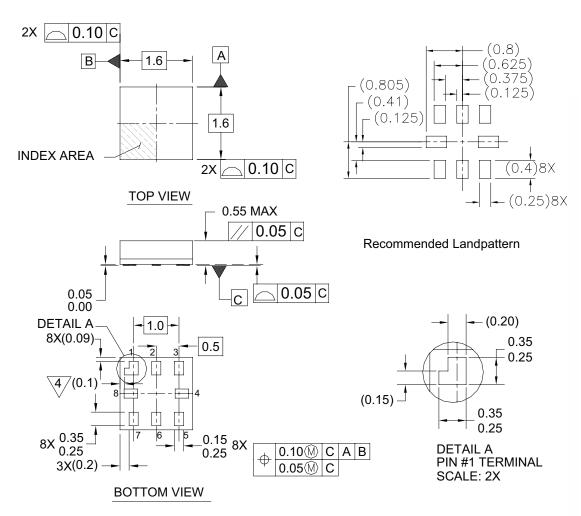
Figure 22. 8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide

For MicroPak™ tape and reel specifications, please visit Fairchild's website: http://www.fairchildsemi.com/ms/MS/MS-522.pdf.

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Physical Dimensions (Continued)



Notes:

- 1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y.14M-1994
- 4/PIN 1 FLAG, END OF PACKAGE OFFSET
- 5. DRAWING FILE NAME: MKT-MAC08AREV4

MAC08AREV4

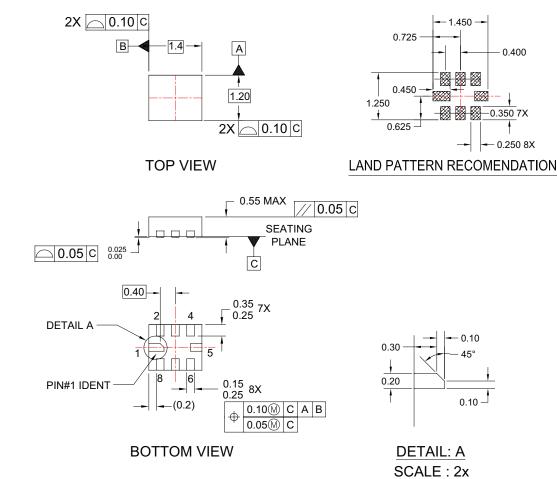
Figure 23. 8-Lead MicroPak, 1.6mm Wide

For MicroPak™ tape and reel specifications, please visit Fairchild's website: http://www.fairchildsemi.com/products/logic/pdf/micropak_tr.pdf.

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Physical Dimensions (Continued)



NOTES:

- A. DOES NOT CONFORMS TO JEDEC STANDARD.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES CONFORMS TO ASME Y14.5M, 1994.
- D. DRAWING FILE NAME: UMLP08Arev1

Figure 24. 8-Lead, Ultrathin Molded Leadless Package (UMLP), 1.2 x 1.4mm

For MicroPak™ tape and reel specifications, please visit Fairchild's website: http://www.fairchildsemi.com/products/logic/pdf/micropak_tr.pdf.

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Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

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Definition of Terms

Datasheet Identification	Product Status	Definition			
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